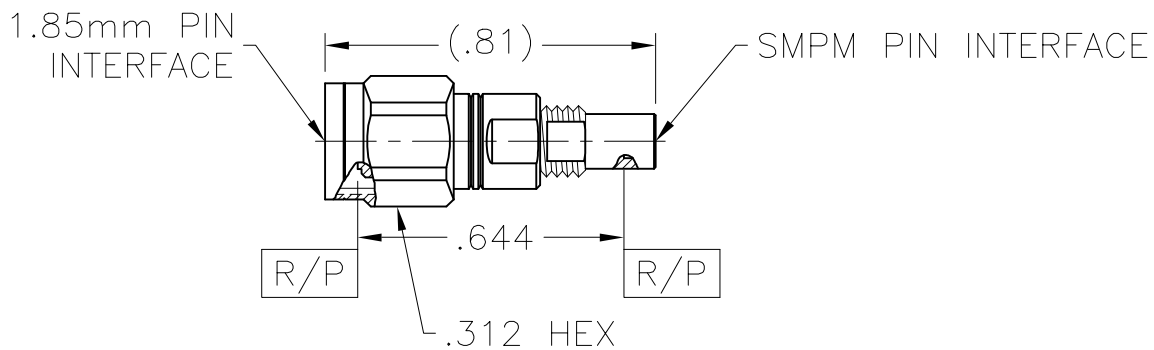
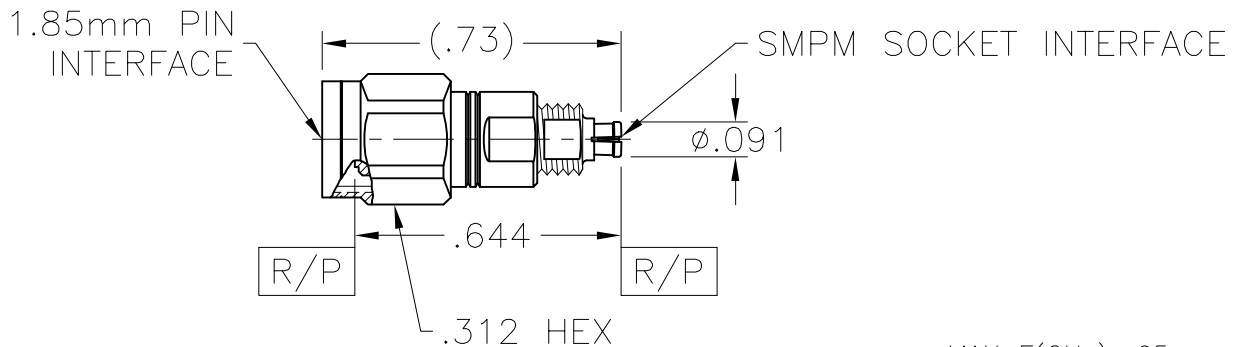


COMPONENT	MATERIAL	FINISH
CONTACT	BeCu TEMPER TD04, ALLOY C17300, ASTM B196	GOLD PLATE PER ASTM B-488 50 MICRONS MIN. OVER NICKEL PLATE PER MIL-C-26074, 30 MICRONS MIN.
INSULATORS	PTFE, ASTM D1710, TYPE I, GRADE 1, CLASS A, AND ULTEM PER ASTM D5205	-
SMPM SOCKET BODY	BeCu TEMPER TD04, ALLOY C17300, ASTM B196	GOLD PLATE PER ASTM B-488 50 MICRONS MIN. OVER NICKEL PLATE PER QQ-N-290, 50 MICRONS MIN.
COUPLING NUT/ SMPM SHROUD	303 STAINLESS STEEL COND. A PER ASTM A582	PASSIVATE PER QQ-P-35C, TYPE II

**100-123-0098**  
**1.85mm Pin<>SMPM Full Detent Pin**



**100-123-0099**  
**1.85mm Pin<>SMPM Socket**



MAX F(GHz): 65

NOTE:  
ALL DIMENSIONS NOMINAL UNLESS  
OTHERWISE SPECIFIED

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INSERTION/EXTRACTION TOOL -	TITLE 1.85mm PIN<>SMPM TEST ADAPTER		
MOUNTING PROCEDURE -	CATALOG NUMBER <b>SEE ABOVE</b>	DRAWING NUMBER 510A10460	REV. A